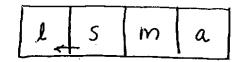
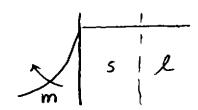
3.044 MATERIALS PROCESSING

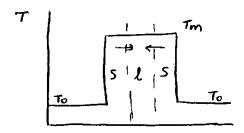
LECTURE 10



1. Casting: Thick mold, mold conduction limiting: $s \propto \sqrt{t} \iff t_f \propto \left(\frac{V}{A}\right)^2$

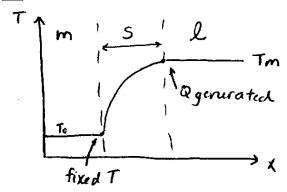


2. Die Casting: Thin cooled mold, interface limiting: $s \propto t$



Date: March 12th, 2012.

3. Thick casting in cooled mold



s/l interface:
$$\frac{ds}{dt} = \frac{k}{H_f \rho} \left(\frac{\partial T}{\partial x} \Big|_x - \frac{\partial T}{\partial x} \Big|_l \right), \text{ where } \frac{\partial T}{\partial x} \Big|_l \Rightarrow 0$$

$$\Theta_{solid} \cong ERF \frac{x}{2\sqrt{\alpha_s t}}$$

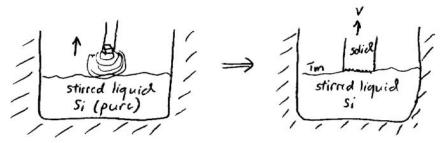
$$\Theta = \frac{T - T_0}{A - T_0}$$

$$s(t) = 2\gamma \sqrt{\alpha_s t}$$

$$t_f \propto \left(\frac{V}{A} \right)^2$$

$$\gamma e^{\gamma^2} ERF \gamma = \frac{(T_m - T_0)c_{p,s}}{H_f \sqrt{\pi}} \Rightarrow \text{Read } \gamma \text{ off chart}$$

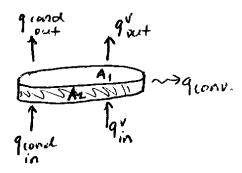
4. Growing single crystal silicon



no T gradients in solid or liquid inert atmosphere: $h \sim 10-20 \frac{W}{m^2 K}$

$$v = \text{pulling velocity} = \frac{ds}{dt} = \frac{k}{H_f \rho} \left(\frac{\partial T}{\partial z} \bigg|_{s} - \frac{\partial T}{\partial z} \bigg|_{l} \right), \text{ where } \left. \frac{\partial T}{\partial z} \right|_{l} \Rightarrow 0$$

Assume steady state:



$$\underbrace{\left(-k \frac{\partial T}{\partial z}\Big|_{\text{in}} A_1\right)}_{\text{fin}} - \underbrace{\left(-k \frac{\partial T}{\partial z}\Big|_{\text{out}} A_1\right)}_{\text{out}} + q_{\text{in}}^v - q_{\text{out}}^v - \underbrace{\left(-h(T - T_f)A_2\right)}_{\text{qconv}} = 0$$

Solve for $q_{\mathbf{in}}^v$ and $q_{\mathbf{out}}^v$:

$$\frac{\text{energy}_{\text{in}}}{\text{time}} = H_{\text{in}} \frac{\text{mass}_{\text{in}}}{\text{time}}$$

$$\dot{m}_w = \rho \dot{V}_{ol}$$

$$\dot{V}_{ol} = \rho A_1 v$$

$$q_{in}^v = \rho A_1 v H_{in}$$

$$q_{out}^v = \rho A_1 v H_{out}$$

$$\Delta H = \rho c_p \Delta T$$

Solve Heat Balance:

$$\frac{T - T_0}{T_f - T_0} = EXP\left(-\left(\frac{v}{2\alpha} - \sqrt{(v2\alpha)^2 + \frac{2h}{Rk}}\right)z\right)$$

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